TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

# 2SC5093

#### VHF~UHF Band Low Noise Amplifier Applications

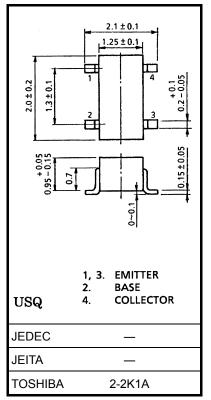
- Low noise figure, high gain.
- NF = 1.8dB,  $|S_{21e}|^2 = 9.5dB$  (f = 2 GHz)

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Collector-base voltage	V <sub>CBO</sub>	20	V	
Collector-emitter voltage	V <sub>CEO</sub>	10	V	
Emitter-base voltage	V <sub>EBO</sub>	1.5	V	
Base current	Ι <sub>Β</sub>	20	mA	
Collector current	Ι <sub>C</sub>	40	mA	
Collector power dissipation	PC	100	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T <sub>stg</sub>	-55~125	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Weight: 0.006 g (typ.)

#### Microwave Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Transition frequency	f <sub>T</sub>	$V_{CE} = 8 V, I_{C} = 20 mA$	7	10	_	GHz	
Insertion gain	S <sub>21e</sub>   <sup>2</sup> (1)	$V_{CE} = 8 \text{ V}, \text{ I}_{C} = 20 \text{ mA}, \text{ f} = 1 \text{ GHz}$	12	15	_	dB	
	S <sub>21e</sub>   <sup>2</sup> (2)	$V_{CE} = 8 \text{ V}, \text{ I}_{C} = 20 \text{ mA}, \text{ f} = 2 \text{ GHz}$	6.5	9.5	_	UD .	
Noise figure	NF (1)	NF (1) $V_{CE} = 8 V$ , $I_C = 5 mA$ , $f = 1 GHz$ —		1.4	2.5	dB	
	NF (2)	$V_{CE} = 8 \text{ V}, \text{ I}_{C} = 5 \text{ mA}, \text{ f} = 2 \text{ GHz}$	_	1.8	3	uв	

#### **Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0$	_	_	1	μA
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB} = 1 V, I_{C} = 0$	_	_	1	μA
DC current gain	h <sub>FE</sub> (Note 1)	$V_{CE} = 8 \text{ V}, \text{ I}_{C} = 20 \text{ mA}$	50	_	160	
Output capacitance	Cob	$V_{CB} = 15 \text{ V}, I_{F} = 0, f = 1 \text{ MHz}$ (Note 2)	_	0.65	1.05	pF
Reverse transfer capacitance	C <sub>re</sub>	$V_{CB} = 15 V, 1E = 0, 1 = 1 M HZ (NOTE 2)$	_	0.45	0.95	pF

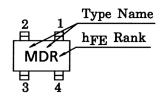
Note 1: hFE classification R: 50~100, O: 80~160

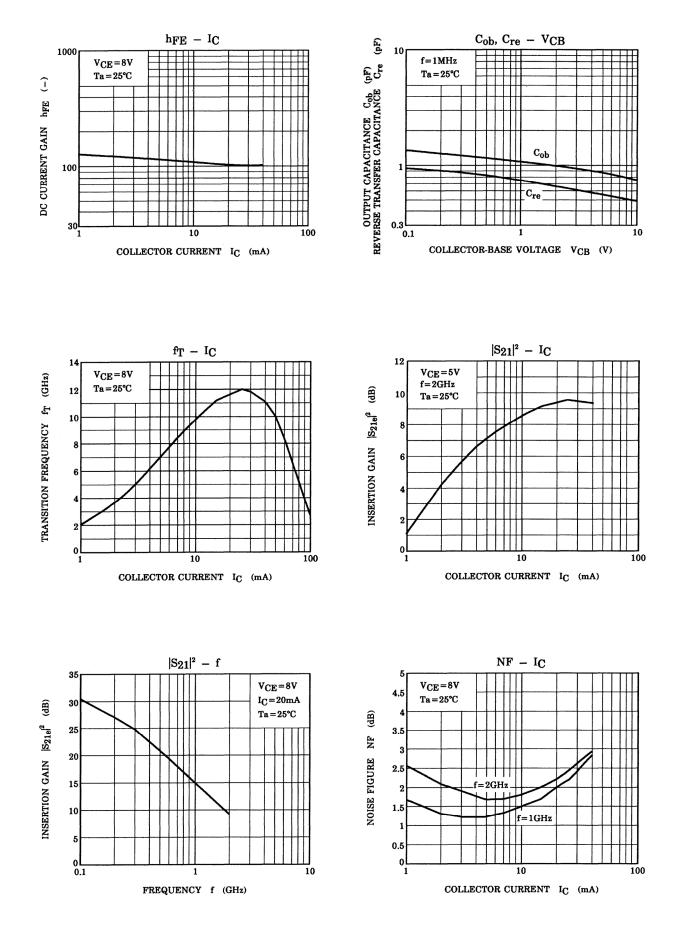
Note 2: Cre is measured by 3 terminal method with capacitance bridge.

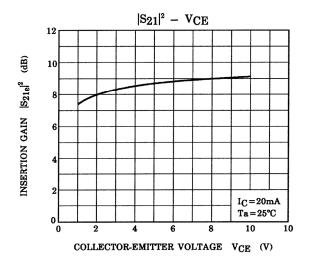
Unit: mm

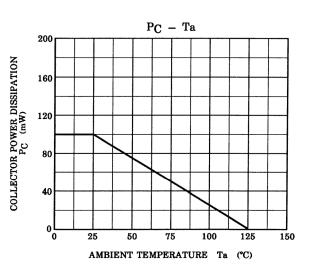
# <u>TOSHIBA</u>

### Marking









### $\label{eq:s-Parameter} \quad \textbf{Z}_{\textbf{O}} = \textbf{50} \ \Omega, \ \textbf{Ta} = \textbf{25}^{\circ}\textbf{C}$

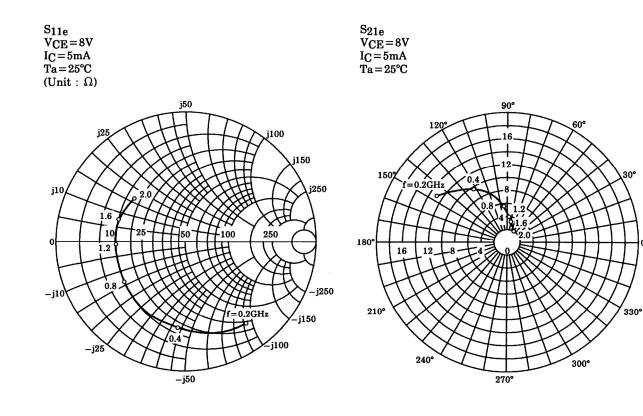
### $V_{CE} = 8 V$ , $I_C = 5 mA$

Frequency	S11		S21		S12		S22	
(MHz)	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
200	0.801	-54.4	12.628	145.4	0.047	63.2	0.864	-32.2
400	0.696	-95.6	9.664	121.9	0.072	48.8	0.675	-54.2
600	0.617	-124.7	7.307	106.2	0.083	42.3	0.543	-68.4
800	0.585	-146.3	5.779	95.1	0.090	39.3	0.456	-79.6
1000	0.554	-163.0	4.674	86.8	0.095	39.5	0.400	-88.6
1200	0.545	-176.5	3.902	80.0	0.099	40.4	0.357	-96.8
1400	0.529	171.3	3.350	75.0	0.103	42.5	0.323	-104.5
1600	0.529	161.1	2.929	70.0	0.108	44.8	0.299	-111.0
1800	0.527	150.4	2.612	66.1	0.116	47.1	0.277	-116.5
2000	0.513	141.0	2.366	62.1	0.122	49.6	0.258	-120.3

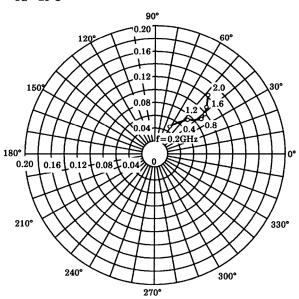
#### $V_{CE} = 8 V$ , $I_C = 20 mA$

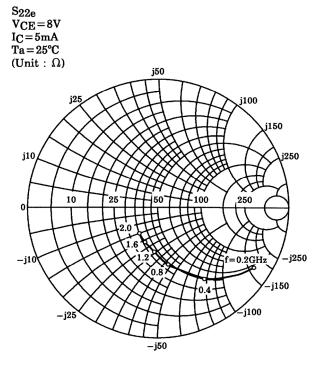
Frequency	S11		S21		S12		S22	
(MHz)	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
200	0.556	-95.4	23.034	126.0	0.032	55.7	0.629	-53.5
400	0.521	-137.0	13.888	105.1	0.045	52.0	0.407	-75.8
600	0.505	-160.0	9.597	94.2	0.054	54.0	0.311	-89.3
800	0.505	-174.7	7.272	86.8	0.064	56.4	0.263	-101.3
1000	0.508	172.6	5.797	81.0	0.075	59.0	0.233	-112.0
1200	0.519	163.1	4.800	76.5	0.085	60.4	0.208	-122.9
1400	0.518	153.4	4.119	72.8	0.095	62.0	0.189	-132.7
1600	0.525	144.3	3.603	69.1	0.106	63.2	0.172	-141.7
1800	0.532	135.6	3.231	66.4	0.119	63.8	0.153	-149.3
2000	0.523	125.9	2.952	62.8	0.131	64.6	0.131	-153.9

0°





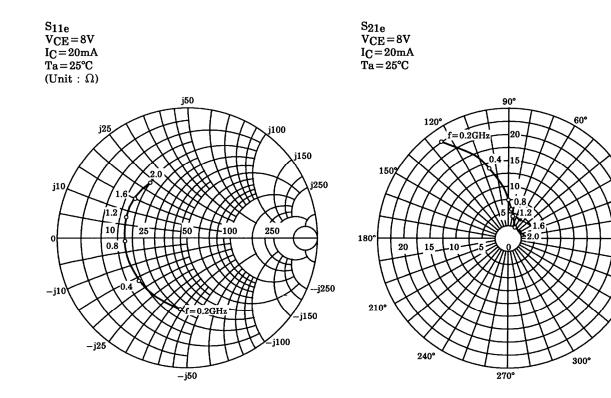


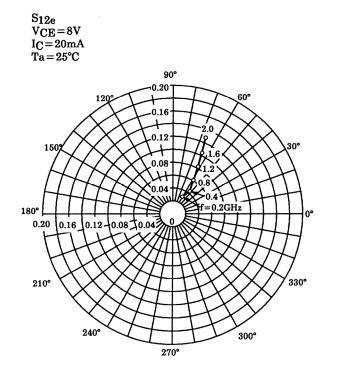


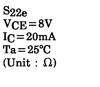
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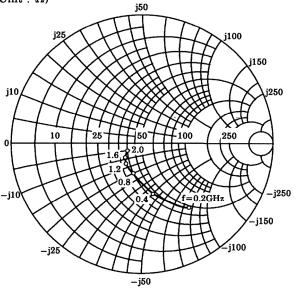
0°

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